

New Product

Vishay Semiconductors formerly General Semiconductor

> Reverse Voltage 50 to 800 V Forward Current 2.0 A

Fast Switching Plastic Rectifier



Features

- Plastic package has Underwriters Laboratories Flammability Classification 94V-0
- High surge current capability
- · Construction utilizes void-free molded plastic technique
- Fast switching for high efficiency
- High temperature soldering guaranteed: 250°C/10 seconds, 0.375" (9.5mm) lead length, 5 lbs. (2.3kg) tension
- Low cost construction
- Low reverse leakage

Mechanical Data

Case: JEDEC DO-204AC molded plastic body Terminals: Plated axial leads, solderable per MIL-STD-750, Method 2026 Polarity: Color band denotes cathode end Mounting Position: Any Weight: 0.015 oz., 0.4 g

Maximum Ratings & Thermal Characteristics Ratings at 25 °C ambient temperature unless otherwise specified.

| Parameter | Symbol | RP 200A | RP 200B | RP 200D | RP 200G | RP 200J | RP 200K | Unit |
|--|------------------|-------------|------------|------------|------------|------------|------------|------|
| Maximum repetitive peak reverse voltage | Vrrm | 50 | 100 | 200 | 400 | 600 | 800 | V |
| Maximum RMS voltage | Vrms | 35 | 70 | 140 | 280 | 420 | 560 | V |
| Maximum DC blocking voltage | VDC | 50 | 100 | 200 | 400 | 600 | 800 | V |
| Maximum average forward rectified current $0.375"$ (9.5mm) lead length at TA = 75° C | IF(AV) | 2.0 | | | | | | A |
| Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method) | IFSM | 70 | | | | | | A |
| Typical thermal resistance (Note 1) | R _{θJA} | 40 | | | | | | °C/W |
| Operating junction and storage temperature range | TJ, TSTG | -65 to +150 | | | | | | °C |

Electrical Characteristics Ratings at 25°C ambient temperature unless otherwise specified.

| Parameter | Symbol | RP 200A | RP 200B | RP 200D | RP 200G | RP 200J | RP 200K | Unit |
|--|--------|------------|------------|------------|------------|------------|------------|------|
| Maximum instantaneous forward voltage at 2.0A | VF | 1.3 | | | | | | V |
| Maximum DC reverse current $T_A = 25^{\circ}C$ at rated DC blocking voltage $T_A = 100^{\circ}C$ | IR | 5.0 200 | | | | | | μA |
| Maximum reverse recovery time $I_F = 0.5A$, $I_R = 1.0A$, $I_{rr} = 0.25A$ | trr | 150 | | | 250 | 500 | ns | |
| Typical junction capacitance at 4.0V, 1MHz | CJ | 25 | | | | | | pF |

Notes:

(1) Thermal resistance from junction to ambient at 0.375" (9.5mm) lead length, P.C.B. mounted

RP200A thru RP200K

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Ratings and

Characteristic Curves (TA = 25°C unless otherwise noted)







Fig. 4 – Typical Reverse Characteristics





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